

Zhenyu Lei

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Education	Huazhong University of Science and Technology (HUST) , Wuhan, Hubei, China B.Eng., Optoelectronic Information Science and Engineering (with honors) GPA 3.93/4.0 <i>Sep, 2016 - Jun, 2020</i>
Research Interests	Ubiquitous Computing, Wearable and Embedded Systems, Wireless Networks, Human Computer Interaction, Cyber-physical Systems, Sensors, VLSI
Research Experience	Cornell University , Ithaca, New York, USA Advisor: Prof. Cheng Zhang <i>Student Intern, Department of Information Science</i> July, 2019 - Present <ul style="list-style-type: none">– Project 1: Investigating the feasibility of recognizing fine-grained activities throughout the home by monitoring surface vibrations at a single point using laser Doppler vibrometry (In Preparation for IMWUT 2020, first author)<ul style="list-style-type: none">• Put forward the idea of the whole project and led the team• Set up the Laser Doppler Vibrometer and built a data acquisition, signal processing, and machine learning pipeline• Designed and completed the experiment for feasibility and user study• Did a thorough literature review including fields of human-computer interaction, optics, mechanical engineering, biomedical, etc.– Project 2: Reconstruction of fine-grained hand gestures using Electrical Impedance Tomography (EIT) (In Process)<ul style="list-style-type: none">• Design a 4-layer PCB for a 2×16-channel EIT system• Develop the firmware of the MCU for scanning• Develop the software for data processing and machine learning– Project 3: ThumbTrak: Recognizing micro-finger poses using a ring with proximity sensing (Submitted to CHI 2020, co-author)<ul style="list-style-type: none">• Made a prototype of a ring-like hardware containing 9 proximity sensors and modified the code of data collection• Wrote part of the paper• Conducted part of the user study– Project 4: Continuous tracking of the thumb of a single hand using high frequency electric currents<ul style="list-style-type: none">• Designed a PCB as the hardware of the project Huazhong University of Science and Technology , Wuhan, Hubei, China Advisor: Prof. Wei Wang <i>Research Assistant, School of Electronic Information and Communications</i> July, 2018 - July, 2019 <ul style="list-style-type: none">– Project: Design of a novel wireless backscatter communication system<ul style="list-style-type: none">• Designed a 4-layer PCB for the backscatter tag working at 900MHz, including the energy-harvesting section and the communication section• Developed the firmware of the MCU which could work at low-power-consuming mode flawlessly– Miscellaneous:<ul style="list-style-type: none">• Developed an FPGA firmware to control 20 antennas simultaneously

- Built a hardware testbench for a Wi-Fi backscatter tag using FPGA

Huazhong University of Science and Technology, Wuhan, Hubei, China

Advisor: Prof. Jing Xu

Research Assistant, School of Optical and Electronic Information

March, 2019 - May, 2019

- Project: **Fast integrated photonic power splitters inverse design using deep learning**
 - Built a model of MultiMode Interference (MMI) light power splitter working at 1550 nm using FDTD Solution
 - Developed Python code for automatically modifying the internal structure of the splitter and generating the simulation results as the dataset
 - Developed a neural network to predict the frequency response and inversely design the structure of MMI

Huazhong University of Science and Technology, Wuhan, Hubei, China

Advisor: Prof. Ming Xu

Research Assistant, School of Optical and Electronic Information

April, 2017 - May, 2018

- Project 1: **Structural disorder in the high-temperature cubic phase of GeTe**
 - Completed a paper as a co-author
 - Developed a program to calculate the distribution of the distances between the atomic trajectories and their central positions
- Project 2: **Research on the ion migration path in Sc_2WO_3 as a kind of electrolyte of solid-state-battery**
 - Calculated and analyzed the migration path of Sc ions using ab initio method in VASP

Publications and Submissions

1. **Zhenyu Lei**, Wei Sun, Peng He, Benjamin Steeper, and Cheng Zhang. Investigating the feasibility of recognizing fine-grained activities throughout the home by monitoring surface vibrations at a single point using laser doppler vibrometry. ***In Preparation for Proceedings of the ACM on Interactive, Mobile, Wearable and Ubiquitous Technologies (IMWUT) 2020***
2. Wei Sun, Congshu Huang, **Zhenyu Lei**, Benjamin Steeper, Songyun Tao, Feng Tian, and Cheng Zhang. Thumbtrak: Recognizing micro-finger poses using a ring with proximity sensing. ***Submitted to ACM Conference on Human Factors in Computing Systems (CHI) 2020***
3. Wei Sun, Songlin Xu, Benjamin Steeper, Congshu Huang, **Zhenyu Lei**, Feng Tian, and Cheng Zhang. Teethtap: Recognizing discrete teeth gestures using motion and acoustic sensing on an earpiece. ***Submitted to ACM Conference on Human Factors in Computing Systems (CHI) 2020***
4. Ming Xu, **Zhenyu Lei**, Junhui Yuan, Kanhao Xue, Yanrong Guo, Songyou Wang, Xiangshui Miao, and Riccardo Mazzarello. Structural disorder in the high-temperature cubic phase of GeTe. *RSC advances*, 8(31):17435-17442, 2018

Extra-curriculum and Projects

- **Oct, 2016-Jun, 2018** Team leader, Electrical and Electronic Technology Innovation Center, HUST
- **Mar, 2018-Jun, 2018** Group member, Special Interest Group on Fiber Embedded Microfluidic Chip for Molecular Detection, HUST
- **Dec, 2018** Group member, group work on Optics Metasurface and Invisibility Cloak, HUST
- **Jul, 2017** Team leader, group work on 3D printing, HUST

Honors and Awards

- Outstanding Undergraduate of Academic Performance (**Top 1%**), HUST, 2018
- Scholarship for Excellent Academic Performance, HUST, 2018
- Scholarship for Innovation, HUST, 2017 & 2018

Skills

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- Programming Language: C, MATLAB, Python, SystemVerilog, L^AT_EX
 - Circuits: Altium Designer, Pspice
 - Mechanics: SolidWorks, AutoCAD, Autodesk Inventor
 - Optics: Zemax, FDTD Solutions
 - Materials: VASP, Materials Studio
 - Multimedia: Adobe Pr, Ae, Au, Ps